

TEL: 86-755-23037763

Mobile: +86-139-2528-0716

Web: www.kingtechgroup.cn



SPECIFICATION

Product Model: PV02808LZR50H

DESIGNED	CHECKED	Approved
研发部	研发部	研发部
2019.09.27	2019.09.27	2019.09.27
Aleck	Hones	Mike

Approval by Customer:

Ok

NG, Problem survey

Approved By

Rev.V1 1/23





Mobile: +86-139-2528-0716

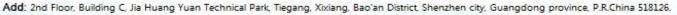
Web: www.kingtechgroup.cn



Revision Record

REV NO.	REV DATE	CONTENTS	Note
V0	2018.07.24	NEW ISSUE	
V1	2019.09.27	Delete double tape and revised FPC outline	P5

Rev.V1 2/23





Mobile: +86-139-2528-0716





Table of Contents

List	Description	Page No.
	Cover	1
	Revision Record	2
	Table of Contents	3
1	Scope	4
2	General Information	4
3	External Dimensions	5
4	Interface Description	6
5	Absolute Maximum Ratings	8
6	DC Characteristics	8
7	Timing Characteristics	9
8	Backlight Characteristics	14
9	Optical Characteristics	15
10	Reliability Test Conditions and Methods	17
11	Inspection Standard	18
12	Handling Precautions	22
13	Precaution for Use	23
14	Packing Method	23

Rev.V1 3/23

E-mail: Helen@kingtechgroup.cn TEL: 86-755- 23037763

Mobile: +86-139-2528-0716

Web: www.kingtechgroup.cn



1. Scope

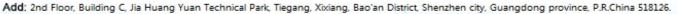
This specification defines general provisions as well as inspection standards for TFT module supplied by Kingtech Group Co.,Ltd.

If the event of unforeseen problem or unspecified items may occur, naturally shall negotiate and agree to solution.

2. General Information

ITEM	STANDARD VALUES	UNITS
LCD type	2.8"TFT	
Dot arrangement	240(RGB)×320	dots
Color filter array	RGB vertical stripe	
Display mode	Transmission / Normally Black	-
Gray Scale Inversion Direction	80/80/80	
Eyes Viewing Direction	ALL	
Driver IC	ST7789V	
Module size	50.0(W)×69.2(H)×2.5(T)	mm
Active area	43.2(W)×57.6(H)	mm
Dot pitch	0.18(W)×0.18(H)	mm
Interface	i80-system 8/16/18-bit MCU interface 3SPI/4SPI/ 16/18-bit RGB interface	
Operating temperature	-20 ~ +70	°C
Storage temperature	-30 ~ +80	°C
Back Light	4 White LED	
Weight	TBD	g

Rev.V1 4/23



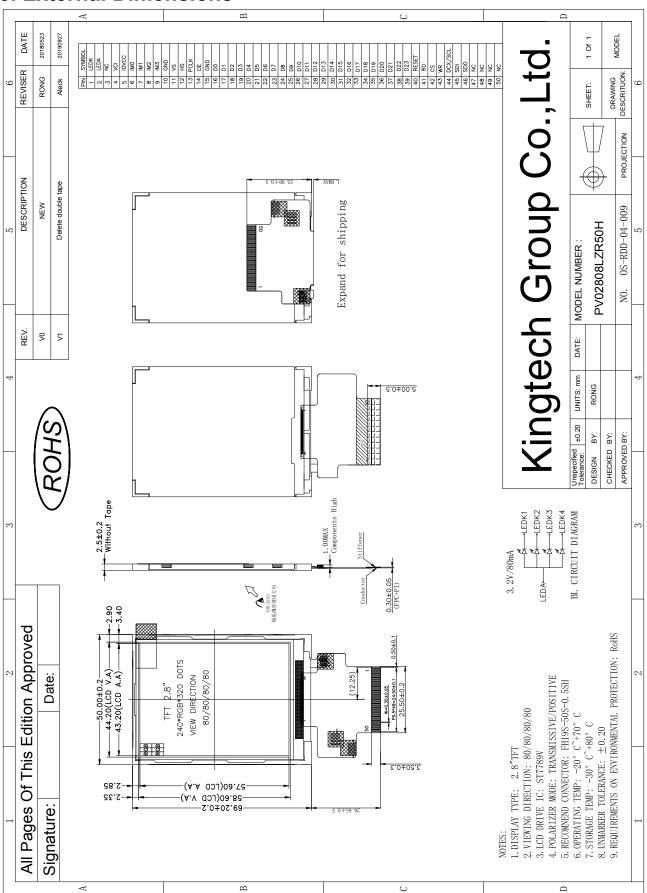


Mobile: +86-139-2528-0716

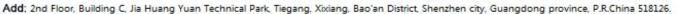
Web: www.kingtechgroup.cn



3. External Dimensions



Rev.V1 5/23





7763 Mobile: +86-139-2528-0716

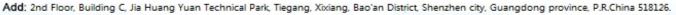
Web: www.kingtechgroup.cn



4. Interface Description

PIN NO.	PIN NAME	DESCRIPTION			
1	LEDK	The Anode of LED power			
2	LEDA	The cathode of LED power			
3	NC	IC			
4	VCI	nalog operating voltage.			
5	IOVCC	Logic operating voltage.			
6~9	IM0~IM3	MPU interface mode select pin,(FYI NOTE1)			
10	GND	Power ground			
11	VSYNC	Frame synchronizing signal for RGB interface operation.			
12	HSYNC	Line synchronizing signal for RGB interface operation.			
13	DOTCLK	Dot clock signal for RGB interface operation.			
14	DE	Data enable signal for RGB interface operation.			
15	GND	Power ground			
16-33	DB0-DB17	Data bus			
34`39	DB18~DB23	NC			
40	RESET	Reset pin setting either pin low initializes the LSI Must be reset after power supplied			
41	RD	Read signal input terminal, Active at 'L'.			
42	CS	Chip select signal input terminal, Active at 'L'			
43	/WR	Write enable in MCU parallel interface Display data/command selection pin in 4-line serial interface Second Data lane in 2 data lane serial interfaceIf not used, please fix this pin at VDDI or DGND.			
44	DCX /SCL	Display data/command selection pin in parallel interface. This pin is used to be serial interface clock DCX='1': display data or parameter DCX='0': command data.			
45	SDI	When IM [3]: Low, Serial in/out signal. When IM [3]: High, Serial input signal. The data is applied on the rising edge of the SCL signal.			
46	SDO	Serial output signal. The data is applied on the rising edge of the SCL signal.			
47	NC	NC.			
48	NC	NC.			

Rev.V1 6/23



TEL: 86-755- 23037763

Mobile: +86-139-2528-0716

Web: www.kingtechgroup.cn



49	NC	NC.
50	NC	NC.

Note1:

-The MCU interface mode select.

IM3	IM2	IM1	IM0	MPU Interface Mode	Data pin
0	0	0	0	80-8bit parallel I/F	DB[7:0]
0	0	0	1	80-16bit parallel I/F	DB[15:0]
0	0	1	0	80-9bit parallel I/F	DB[8:0]
0	0	1	1	80-18bit parallel I/F	DB[17:0],
,		•	2	3-line 9bit serial I/F	SDA: in/out
0	1	0	1	2 data lane serial I/F	SDA: in/out WRX: in
0	1	1	0	4-line 8bit serial I/F	SDA: in/out
1	0	0	0	80-16bit parallel I/F Ⅱ	DB[17:10], DB[8:1]
1	0	0	1	80-8bit parallel I/F Ⅱ	DB[17:10]
1	0	1	0	80-18bit parallel I/F Ⅱ	DB[17:0],
1	0	1	1	80-9bit parallel I/F Ⅱ	DB[17:9]
1	1	0	1	3-line 9bit serial I/F Ⅱ	SDA: in/
		U	1	3-IIIIe anii seliai I/F II	SDO: out
1	1	1	0	4-line 8bit serial I/F Ⅱ	SDA:in/
10 A	1	1	U	4-line out send i/F II	SDO: out

If not used, please fix this pin at VDDI or DGND.

Rev.V1 7/23

E-mail: Helen@kingtechgroup.cn TEL: 86-755- 23037763

Mobile: +86-139-2528-0716

Web: www.kingtechgroup.cn



5. Absolute Maximum Ratings

Item	Symbol	Min.	Max.	Unit
Logic Supply Voltage	IOVCC	-0.3	4.6	V
Analog Supply Voltage	VCI	-0.3	4.6	V
Input Voltage	Vin	-0.3	IOVCC +0.3	V
Operating Temperature	Тор	-20	70	°C
Storage Temperature	Тѕт	-30	80	°C
Storage Humidity	HD	20	90	%RH

6. DC Characteristics

Item	Symbol	Min.	Тур.	Max.	Unit	Remark
Logic Supply Voltage	IOVCC	1.65	2.8	3.3	V	-
Analog Supply Voltage	VCI	2.5	2.8	3.3	V	-
Input High Voltage	V _{IH}	0.7VCI	-	IOVCC	V	-
Input Low Voltage	V _{IL}	GND	-	0.3 IOVCC	V	-
Output High Voltage	V_{OH}	0.8 VCI	-	IOVCC	V	-
Output Low Voltage	V _{OL}	GND	-	0.2 IOVCC	V	-
I/O Leak Current	ILI	-1	-	1	uA	-
Supply Current	IDD	-	7.0	10	mA	-

Rev.V1 8/23





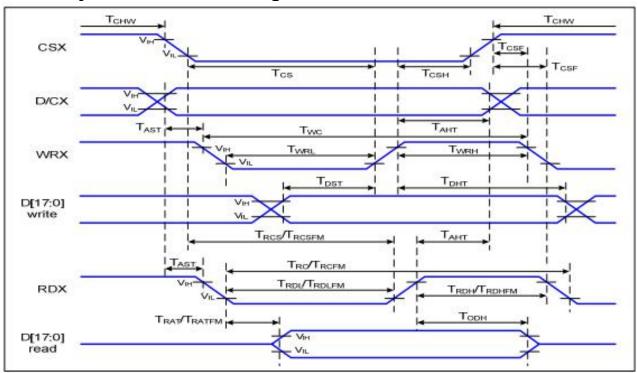
Mobile: +86-139-2528-0716





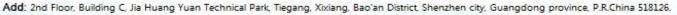
7. Timing Characteristics

7.1 i80-System Interface Timing Characteristics



Signal	Symbol	Parameter	Min	Max	Unit	Description	
D/CX	T _{AST}	Address setup time	0		ns	8	
D/CX	T _{AHT}	Address hold time (Write/Read)	10		ns		
-	T _{CHW}	Chip select "H" pulse width	0		ns	×	
	T _{CS}	Chip select setup time (Write)	15		ns	·	
CSX	T _{RCS}	Chip select setup time (Read ID)	45		ns		
CSA	T _{RCSFM}	Chip select setup time (Read FM)	355		ns	•	
3	T _{CSF}	Chip select wait time (Write/Read)	10		ns		
	T _{CSH}	Chip select hold time	10		ns	8	
	T _{wc}	Write cycle	66		ns		
WRX	T _{WRH}	Control pulse "H" duration	15		ns	2	
	T _{WRL}	Control pulse "L" duration	15		ns	2	
	T _{RC}	Read cycle (ID)	160		ns	8	
RDX (ID)	T _{RDH}	Control pulse "H" duration (ID)	90		ns	When read ID data	
	T _{RDL}	Control pulse "L" duration (ID)	45		ns		
DDV	T _{RCFM}	Read cycle (FM)	450		ns	When read from	
RDX (FM)	T _{RDHFM}	Control pulse "H" duration (FM)	90		ns	When read from	
	T _{RDLFM}	Control pulse "L" duration (FM)	355		ns	frame memory	
D[17:0]	T _{DST}	Data setup time	10		ns	For CL=30pF	

Rev.V1 9/23



TEL: 86-755-23037763

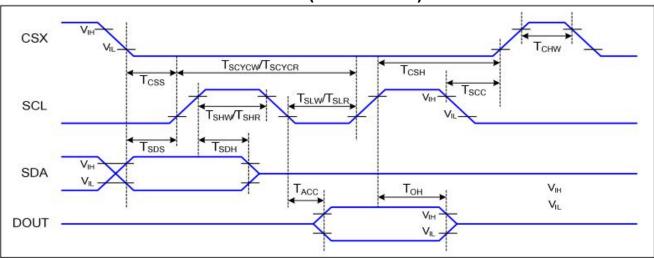
Mobile: +86-139-2528-0716

Web: www.kingtechgroup.cn



T _{DHT}	Data hold time	10		ns	
T _{RAT}	Read access time (ID)		40	ns	
T _{RATEM}	Read access time (FM)		340	ns	
T _{ODH}	Output disable time	20	80	ns	

7.2 Serial Interface Characteristics (3-line serial):



VDDI=1.65 to 3.3V, VDD=2.4 to 3.3V, AGND=DGND=0V, Ta=-30 to 70 ℃

Signal	Symbol	Parameter	Min	Max	Unit	Description
	T _{CSS}	Chip select setup time (write)	15		ns	
	T _{CSH}	Chip select hold time (write)	15		ns	
CSX	T _{CSS}	Chip select setup time (read)	60		ns	
	T _{SCC}	Chip select hold time (read)	65	2 3	ns	
	T _{CHW}	Chip select "H" pulse width	40		ns	
	T _{SCYCW}	Serial clock cycle (Write)	66		ns	
	T _{SHW}	SCL "H" pulse width (Write)	15		ns	
SCL	T _{SLW}	SCL "L" pulse width (Write)	15		ns	
SCL	T _{SCYCR}	Serial clock cycle (Read)	150		ns	
	T _{SHR}	SCL "H" pulse width (Read)	60		ns	
	T _{SLR}	SCL "L" pulse width (Read)	60		ns	
SDA	T _{SDS}	Data setup time	10		ns	
(DIN)	T _{SDH}	Data hold time	10		ns	
DOUT	T _{ACC}	Access time	10	50	ns	For maximum CL=30pF
DOUT	Тон	Output disable time	15	50	ns	For minimum CL=8pF

Rev.V1 10/23

E-mail: Helen@kingtechgroup.cn

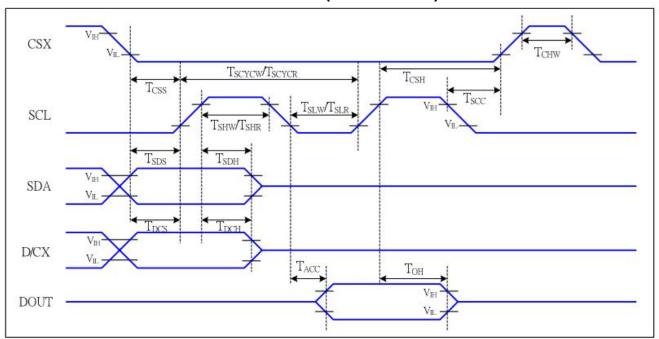
TEL: 86-755-23037763

Mobile: +86-139-2528-0716

Web: www.kingtechgroup.cn



7.3 Serial Interface Characteristics (4-line serial):



VDDI=1.65 to 3.3V, VDD=2.4 to 3.3V, AGND=DGND=0V, Ta=-30 to 70 ℃

Signal	Symbol	Parameter	MIN	MAX	Unit	Description
	T _{CSS}	Chip select setup time (write)	15		ns	
	T _{CSH}	Chip select hold time (write)	15		ns	
CSX	T _{CSS}	Chip select setup time (read)	60		ns	
	T _{SCC}	Chip select hold time (read)	65		ns	
	T _{CHW}	Chip select "H" pulse width	40		ns	
	T _{SCYCW}	Serial clock cycle (Write)	66		ns	unite command 0 date
	T _{SHW}	SCL "H" pulse width (Write)			ns	-write command & data
SCL	T _{SLW}	SCL "L" pulse width (Write)	15		ns	ram
SCL	T _{SCYCR}	T _{SCYCR} Serial clock cycle (Read)			ns	
	T _{SHR}	SCL "H" pulse width (Read)	60		ns	-read command & data
	T _{SLR}	SCL "L" pulse width (Read)	60		ns	ram
DIOV	T _{DCS}	D/CX setup time	10		ns	
D/CX	T _{DCH}	D/CX hold time	10		ns	
SDA	T _{SDS}	Data setup time	10		ns	
(DIN)	T _{SDH}	Data hold time	10		ns	
DOUT	T _{ACC}	Access time	10	50	ns	For maximum CL=30pF
וטטטו	Тон	Output disable time	15	50	ns	For minimum CL=8pF

Rev.V1 11/23

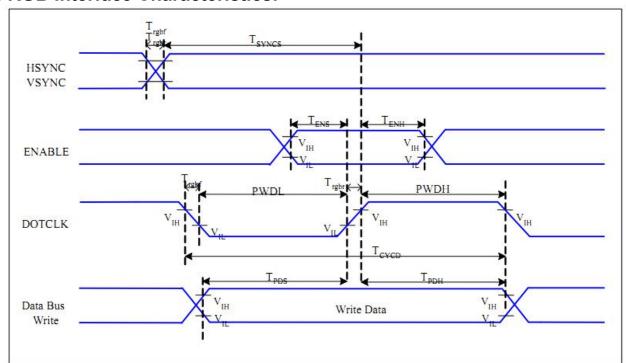
TEL: 86-755-23037763

Mobile: +86-139-2528-0716

Web: www.kingtechgroup.cn



7.4 RGB Interface Characteristics:



Signal	nal Symbol Parameter		MIN	MAX	Unit	Description
HSYNC, VSYNC	Tsyncs VSYNC, HSYNC Setup Time		30	(=)	ns	
ENIABLE	T _{ENS}	Enable Setup Time	25		ns	
ENABLE	T _{ENH}	Enable Hold Time	25		ns	
	PWDH	DOTCLK High-level Pulse Width	60		ns	
DOTCLK	PWDL	DOTCLK Low-level Pulse Width	60	•	ns	
DOTCER	T _{CYCD}	DOTCLK Cycle Time	120	-	ns	
	Trghr, Trghf	DOTCLK Rise/Fall time	-	20	ns	
DB	T _{PDS}	PD Data Setup Time	50	120	ns	
	T _{PDH}	PD Data Hold Time	50	343	ns	

Table 7 18/16 Bits RGB Interface Timing Characteristics

Rev.V1 12/23



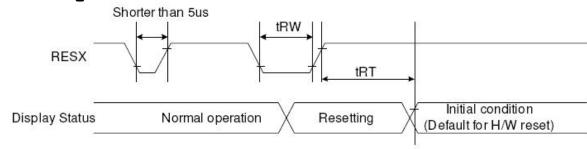
TEL: 86-755-23037763

Mobile: +86-139-2528-0716

Web: www.kingtechgroup.cn



7.5 Reset Timing Characteristics



Signal	Symbol	Parameter	Min	Max	Unit
RESX	tRW	Reset pulse duration	10		uS
tRT		Reset cancel		5 (note 1,5)	mS
	thi Heset can	neset cancel		120 (note 1,6,7)	mS

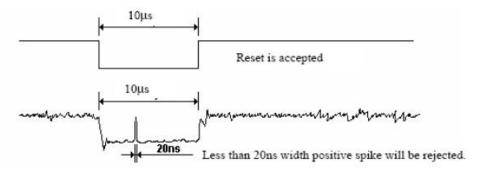
Note 1: The reset cancel includes also required time for loading ID bytes, VCOM setting and other settings from NV memory to registers. This loading is done every time when there is HW reset cancel time (tRT) within 5 ms after a rising edge of RESX.

Note 2: Spike due to an electrostatic discharge on RESX line does not cause irregular system reset according to the table below: -

RESX Pulse	Action	
Shorter than 5us	Reset Rejected	
Longer than 10us	Reset	
Between 5us and 10us	Reset starts	

Note 3: During the Resetting period, the display will be blanked (The display is entering blanking sequence, which maximum time is 120 ms, when Reset Starts in Sleep Out –mode. The display remains the blank state in Sleep In -mode.) And then return to Default condition for Hardware Reset.

Note 4: Spike Rejection also applies during a valid reset pulse as shown below:



- Note 5: When Reset applied during Sleep In Mode.
- Note 6: When Reset applied during Sleep Out Mode.
- Note 7: It is necessary to wait 5msec after releasing RESX before sending commands. Also Sleep Out command cannot be sent for 120msec.

Rev.V1 13/23

E-mail: Helen@kingtechgroup.cn

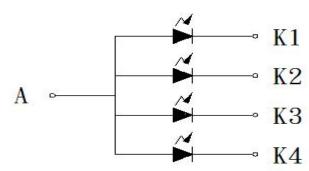
TEL: 86-755-23037763

Mobile: +86-139-2528-0716

Web: www.kingtechgroup.cn



8. Backlight Characteristic



Item	Symbol	MIN	TYP	MAX	UNIT	Test Condition
Supply Voltage	Vf	2.9	3.2	3.5	V	lf=80mA
Supply Current	lf	-	80		mA	-
Luminous Intensity for LCM	-	200	250	-	cd/m ²	If=80mA
Uniformity for LCM	-	75	80	_	%	lf=80mA
Life Time	-	50000	-	_	Hr	lf=80mA
Backlight Color	White					

Rev.V1 14/23





Mobile: +86-139-2528-0716

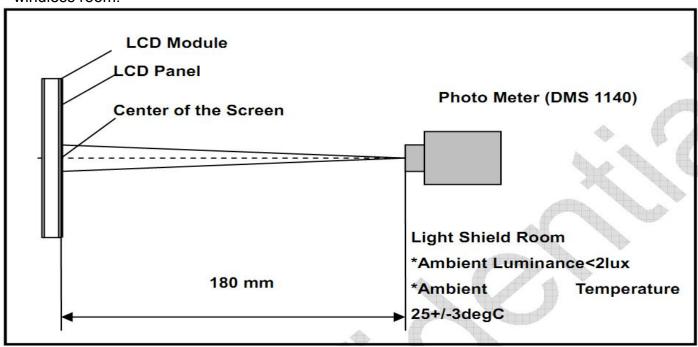
Web: www.kingtechgroup.cn



9. Optical Characteristics

Item	Conditions		Min.	Тур.	Max.	Unit	Note	
	Horizontal	θL	-	80	-			
Viewing Angle	HOHZOHIAI	θR	-	80	-	.1	(4) (2) (6)	
(CR>10)	Vartical	θт	-	80	-	degree	(1),(2),(6)	
	Vertical	θв	-	80	-			
Contrast Ratio	Center		600	800	-	-	(1),(3),(6)	
Response Time	Rising + Fal	ling	_	16	_	ms	(1),(4),(6)	
	Red x					-		
	Red y Green x Green y Blue x					-		
					Тур.	-		
CF Color						-	(4) (6)	
Chromaticity (CIE1931)			Тур.				(1), (6)	
(0.2.00.)	Blue y		-0.05		+0.05	-		
	White x					-		
	White y					-		
NTSC	CIE1931		-	60	-	%	(1),(6)	

Note (1) Measurement Setup: The LCD module should be stabilized at given temp. 25°C for 15 minutes to avoid abrupt temperature change during measuring. In order to stabilize the luminance, the measurement should be executed after lighting backlight for 15 minutes in a windless room.



Note (2) Definition of Viewing Angle

Rev.V1 15/23

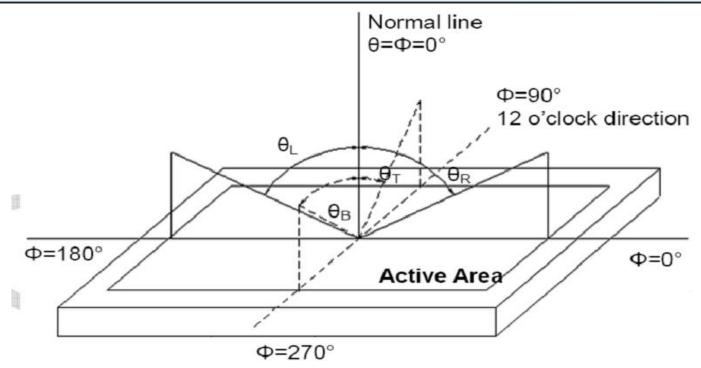
E-mail: Helen@kingtechgroup.cn

TEL: 86-755-23037763

Mobile: +86-139-2528-0716

Web: www.kingtechgroup.cn



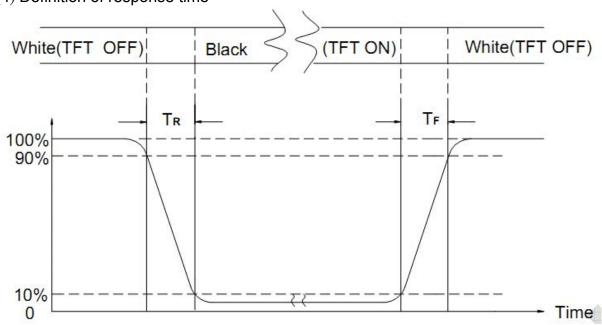


Note (3) Definition of Contrast Ratio (CR)

The contrast ratio can be calculated by the following expression Contrast Ratio (CR) = L63 / L0

L63: Luminance of gray level 63, L0: Luminance of gray level 0

Note (4) Definition of response time



Note (5) Definition of Transmittance (Module is without signal input)

Transmittance = Center Luminance of LCD / Center Luminance of Back Light x 100%

Note (6) Definition of color chromaticity (CIE1931)

Color coordinates measured at the center point of LCD

Rev.V1 16/23



TEL: 86-755-23037763

Mobile: +86-139-2528-0716

Web: www.kingtechgroup.cn



10. Reliability Test Conditions and Methods

NO.	TEST ITEMS	TEST CONDITION	INSPECTION AFTER TEST
1)	High Temperature Storage	80°C±2°C×96Hours	
2	Low Temperature Storage	-30°C±2°C×96Hours	
3	High Temperature Operating	70°C±2°C×96Hours	
4	Low Temperature Operating	-20°C±2°C×96Hours	Inspection after 2~4hours storage at room temperature, the samples
(5)	Temperature Cycle(Storage)	-20°C \Longrightarrow 25°C \Longrightarrow 70°C (30min) (30min) 1cycle Total 10cycle	should be free from defects: 1, Air bubble in the LCD. 2, Seal leak. 3, Non-display. 4, Missing segments.
6	Damp Proof Test (Storage)	50°C±5°C×90%RH×120Hours	5, Glass crack.6, Current IDD is twice
7	Vibration Test	Frequency:10Hz~55Hz~10Hz Amplitude:1.5MM X,Y,Z direction for total 3hours (packing condition test will be tested by a carton)	higher than initial value. 7, The surface shall be free from damage. 8, The electric characteristic requirements shall be satisfied.
8	Drooping Test	Drop to the ground from 1M height one time every side of carton. (packing condition test will be tested by a carton)	Shan be saushed.
9	ESD Test	Voltage:±8KV,R:330Ω,C:150PF,Ai r Mode,10times	

REMARK:

- 1, The Test samples should be applied to only one test item.
- 2, Sample side for each test item is 5~10pcs.
- 3, For Damp Proof Test, Pure water(Resistance $> 10 \text{M}\Omega$) should be used.
- 4,In case of malfunction defect caused by ESD damage, if it would be recovered to normal state after resetting, it would be judge as a good part.
- 5, EL evaluation should be accepted from reliability test with humidity and temperature: Some defects such as black spot/blemish can happen by natural chemical reaction with humidity and Fluorescence EL has.
- 6, Failure Judgment Criterion: Basic Specification Electrical Characteristic, Mechanical Characteristic, Optical Characteristic.

Rev.V1 17/23

E-mail: Helen@kingtechgroup.cn

TEL: 86-755- 23037763

Mobile: +86-139-2528-0716

Web: www.kingtechgroup.cn



11. Inspection Standard

11.1. QUALITY:

THE QUALITY OF GOODS SUPPLIED TO PURCHASER SHALL COME UP TO THE FOLLOWING STANDARD.

11.1.1. THE METHOD OF PRESERVING GOODS

AFTER DELIVERY OF GOODS FROM AMSON TO PURCHASER. PURCHASER SHALL CONTROL THE LCM AT -10 °C TO 40 °C , AND IT MIGHT BE DESIRABLE TO KEEP AT THE NORMAL ROOM TEMPERATURE AND HUMIDITY UNTIL INCOMING INSPECTION OR THROWING INTO PROCESS LINE.

11.1.2. INCOMING INSPECTION

(A) THE METHOD OF INSPECTION

IF PURCHASER MAKE AN INCOMING INSPECTION, A SAMPLING PLAN SHALL BE APPLIED ON THE CONDITION THAT QUALITY OF ONE DELIVERY SHALL BE REGARDED AS ONE LOT.

(B) THE STANDARD OF QUALITY

ISO-2859-1 (SAME AS MIL-STD-105E), LEVEL II SINGLE PLAN.

CLASS	AQL(%)
CRITICAL	0.4 %
MAJOR	0.65 %
MINOR	1.5 %
TOTAL	1.5 %

EVERY ITEM SHALL BE INSPECTED ACCORDING TO THE CLASS.

(C) MEASURE

IF AS THE RESULT OF ABOVE RECEIVING INSPECTION, A LOT OUT IS DISCOVERED. PURCHASER SHALL BE INFORM SELLER OF IT WITHIN SEVEN DAYS. BUT FIRST SHIPMENT WITHIN FOURTEEN DAYS.

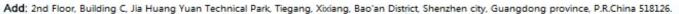
11.1.3. WARRANTY POLICY

AMSON WILL PROVIDE ONE-YEAR WARRANTY FOR THE PRODUCTS ONLY IF UNDER SPECIFICATION OPERATING CONDITIONS. AMSON WILL REPLACE NEW PRODUCTS FOR THESE DEFECT PRODUCTS WHICH UNDER WARRANTY PERIOD AND BELONG TO THE RESPONSIBILITY OF AMSON.

112 CHECKING CONDITION

- 11.2.1. CHECKING DIRECTION SHALL BE IN THE 45 DEGREE AREA TO FACE THE SAMPLE.
- 11.2.2. CHECKER SHALL SEE OVER 300±25 mm. WITH BARE EYES FAR FROM SAMPLE AND USING 2 PCS. OF 20W FLUORESCENT LAMP.

Rev.V1 18/23





Mobile: +86-139-2528-0716

Web: www.kingtechgroup.cn



11.3 INSPECTION PLAN:

CLASS	ITEM	JUDGEMENT	CLASS
PACKING &	OUTSIDE AND INSIDE PACKAGE	"MODEL NO." , "LOT NO." AND "QUANTITY" SHOULD INDICATE ON THE PACKAGE.	Minor
INDICATE	2. MODEL MIXED AND QUANTITY	OTHER MODEL MIXEDREJECTED QUANTITY SHORT OR OVERREJECTED	Critical
	3. PRODUCT INDICATION	"MODEL NO." SHOULD INDICATE ON THE PRODUCT	Major
ASSEMBLY	DIMENSION, LCD GLASS SCRATCH AND SCRIBE DEFECT.	ACCORDING TO SPECIFICATION OR DRAWING.	Major
	5. VIEWING AREA	POLARIZER EDGE OR LCD'S SEALING LINE IS VISABLE IN THE VIEWING AREAREJECTED	Minor
	6. BLEMISH - BLACK SPOT - WHITE SPOT IN THE LCD AND LCD GLASS CRACKS	ACCORDING TO STANDARD OF VISUAL INSPECTION(INSIDE VIEWING AREA)	Minor
APPEARANCE	7. BLEMISH - BLACK SPOT WHITE SPOT AND SCRATCH ON THE POLARIZER	ACCORDING TO STANDARD OF VISUAL INSPECTION(INSIDE VIEWING AREA)	Minor
	8. BUBBLE IN POLARIZER	ACCORDING TO STANDARD OF VISUAL INSPECTION(INSIDE VIEWING AREA)	Minor
	9. LCD'S RAINBOW COLOR	STRONG DEVIATION COLOR (OR NEWTON RING) OF LCDREJECTED. OR ACCORDING TO LIMITED SAMPLE (IF NEEDED, AND INSIDE VIEWING AREA)	Minor
	10. ELECTRICAL AND OPTICAL CHARACTERISTICS (CONTRAST, VOP, CHROMATICITY ETC)	ACCORDING TO SPECIFICATION OR DRAWING . (INSIDE VIEWING AREA)	Critical
ELECTRICAL	11.MISSING LINE	MISSING DOT: LINE : CHARACTERREJECTED	Critical
	12.SHORT CIRCUIT- WRONG PATTERN DISPLAY	NO DISPLAY - WRONG PATTERN DISPLAY - CURRENT CONSUMPTION OUT OF SPECIFICATION REJECTED	Critical
	13. DOT DEFECT (FOR COLOR AND TE		Minor

Rev.V1 19/23





TEL: 86-755- 23037763 Mobile: +86-139-2528-0716 Web: www.kingtechgroup.cn



11.4	. STANI	DARD OF VISUAL INSPECT	TION					
NO.	CLASS	ITEM	JUDGEMENT					
			(A) ROUND TYPE: unit : mm.					
			DIAMETER (mm.) ACCEPTABLE Q'TY					
			$\Phi \leq 0.1$ DISREGARD					
		BLACK AND WHITE SPOT	$0.1 < \Phi \leq 0.25$ 3 (Distance>5mm)					
		FOREIGN MATERIEL	0.25 < Φ					
11.4.1	MINOR	DUST IN THE CELL	NOTE: Φ=(LENGTH+WIDTH)/2					
10.03681,670		BLEMISH	(B) LINEAR TYPE: unit : mm.					
		SCRATCH	LENGTH WIDTH ACCEPTABLE Q'TY					
			W ≤0.03 DISREGARD					
			L ≤ 5.0 0.03 < W ≤ 0.07 3 (Distance>5mm)					
			0.07 < W FOLLOW ROUND TYPE					
\vdash			unit : mm.					
			DIAMETER ACCEPTABLE Q'TY					
		BUBBLE IN POLARIZER	Φ ≤ 0.2 DISREGARD					
11.4.2	MINOR	DENT ON POLARIZER	0.2 < Φ ≤ 0.5 2 (Distance>5mm)					
			0.5 < Ф 0					
	. ,							
			1 100 077					
		B . B	Items ACC. Q'TY					
		Dot Defect	Bright dot $N \le 4$ Dark dot $N \le 4$					
			Dark dot N≦ 4					
			Pixel Define : 1. Divel					
			Pixel Define : Pixel ——					
			RGB					
11.4.3	MINOR							
			◆ Dot → ◆ Dot →					
			Note 1: The definition of dot: The size of a defective dot over					
			1/2 of whole dot is regarded as one defective dot.					
			Note 2: Bright dot: Dots appear bright and unchanged in size					
			in which LCD panel is displaying under black pattern.					
			Note 3: Dark dot: Dots appear dark and unchanged in size in					
			which LCD panel is displaying under pure red, green					
			,blue pattern.					

Rev.V1 20/23



TEL: 86-755-23037763

Mobile: +86-139-2528-0716 Web: www.kingtechgroup.cn



NO.	CLASS	ITEM	JUDGEMEN	T [
11.4.4	MINOR	LCD GLASS CHIPPING	S S	Y > S Reject
11.4.5	MINOR	LCD GLASS CHIPPING	SX	X or Y > S Reject
11.4.6	MAJOR	LCD GLASS GLASS CRACK	Y Y	Y > (1/2) T Reject
11.4.7	MAJOR	LCD GLASS SCRIBE DEFECT	A + B	1. a> L/3 , A>1.5mm. Reject 2. B: ACCORDING TO DIMENSION
11.4.8	MINOR	LCD GLASS CHIPPING (ON THE TERMINAL AREA)	T	$\Phi = (x+y)/2 > 2.5 \text{ mm}$ Reject
11.4.9	MINOR	LCD GLASS CHIPPING (ON THE TERMINAL SURFACE)	TZX	Y > (1/3) T Reject
11.4.10	MINOR	LCD GLASS CHIPPING	T Z	Y > T Reject

Rev.V1 21/23

E-mail: Helen@kingtechgroup.cn TEL: 86-755- 23037763

Mobile: +86-139-2528-0716

Web: www.kingtechgroup.cn



12. Handling Precautions

12.1 Mounting method

The LCD panel of KINGTECH TFT module consists of two thin glass plates with polarizes which easily be damaged. And since the module in so constructed as to be fixed by utilizing fitting holes in the printed circuit board.

Extreme care should be needed when handling the LCD modules.

12.2 Caution of LCD handling and cleaning

When cleaning the display surface, Use soft cloth with solvent

[Recommended below] and wipe lightly

- Isopropyl alcohol
- Ethyl alcohol

Do not wipe the display surface with dry or hard materials that will damage the polarizer surface.

Do not use the following solvent:

- Water
- Aromatics

Do not wipe ITO pad area with the dry or hard materials that will damage the ITO patterns Do not use the following solvent on the pad or prevent it from being contaminated:

- Soldering flux
- Chlorine (CI), Sulfur (S)

If goods were sent without being silicon coated on the pad, ITO patterns could be damaged due to the corrosion as time goes on.

If ITO corrosion happen by miss-handling or using some materials such as Chlorine (CI), Sulfur (S) from customer, Responsibility is on customer.

12.3 Caution against static charge

The LCD module use C-MOS LSI drivers, so we recommended that you:

Connect any unused input terminal to POWER or GROUND, do not input any signals before power is turned on, and ground your body, work/assembly areas, and assembly equipment to protect against static electricity.

12.4 packing

- Module employs LCD elements and must be treated as such.
- Avoid intense shock and falls from a height.
- To prevent modules from degradation, do not operate or store them exposed direct to sunshine or high temperature/humidity

12.5 Caution for operation

- It is an indispensable condition to drive LCD's within the specified voltage limit since the higher voltage then the limit cause the shorter LCD life.
- An electrochemical reaction due to direct current causes LCD's undesirable deterioration, so that the use of direct current drive should be avoided.
- Response time will be extremely delayed at lower temperature then the operating temperature range and on the other hand at higher temperature LCD's how dark color in them. However those phenomena do not mean malfunction or out of order with LCD's, which will come back in the specified operation temperature.
- If the display area is pushed hard during operation, some font will be abnormally displayed but it resumes normal condition after turning off once.
- Slight dew depositing on terminals is a cause for electro-chemical reaction resulting in terminal open circuit.

Usage under the maximum operating temperature, 50%Rh or less is required.

Rev.V1 22/23

E-mail: Helen@kingtechgroup.cn TE

TEL: 86-755- 23037763 Mobile: +86-139-2528-0716

Web: www.kingtechgroup.cn



12.6 storing

In the case of storing for a long period of time for instance, for years for the purpose or replacement use, the following ways are recommended.

- Storage in a polyethylene bag with the opening sealed so as not to enter fresh air outside in it. And with no desiccant.
- Placing in a dark place where neither exposure to direct sunlight nor light's keeping the storage temperature range.
- Storing with no touch on polarizer surface by the anything else.
 [It is recommended to store them as they have been contained in the inner container at the time of delivery from us

12.7 Safety

- It is recommendable to crash damaged or unnecessary LCD's into pieces and wash off liquid crystal by either of solvents such as acetone and ethanol, which should be burned up later.
- When any liquid leaked out of a damaged glass cell comes in contact with your hands, please wash it off well with soap and water

13. Precaution for Use

13.1

A limit sample should be provided by the both parties on an occasion when the both parties agreed its necessity. Judgment by a limit sample shall take effect after the limit sample has been established and confirmed by the both parties.

13.2

On the following occasions, the handing of problem should be decided through discussion and agreement between responsible of the both parties.

- When a question is arisen in this specification
- When a new problem is arisen which is not specified in this specifications
- When an inspection specifications change or operating condition change in customer is reported to KINGTECH TFT, and some problem is arisen in this specification due to the change
- When a new problem is arisen at the customer's operating set for sample evaluation in the customer site.

14. Packing Method

TBD

Rev.V1 23/23